# **Product Specification**

(Preliminary)

Part Name: OEL Display Module Part ID: UG-2864AMBAG01

Doc No.: SAS1-9015-A



From: Univision Technology Inc.

Approved by

# **Univision Technology Inc.**

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# Revised History

UG-2864AMBAG01 A New March 15,2006
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#### 1. Basic Specifications

#### 1.1 Display Specifications

1) Display Mode: Passive Matrix

2) Display Color: Area Color (Light Blue, Yellow)

3) Drive Duty: 1/64 Duty

#### 1.2 Mechanical Specifications

1) Outline Drawing: According to the annexed outline drawing number

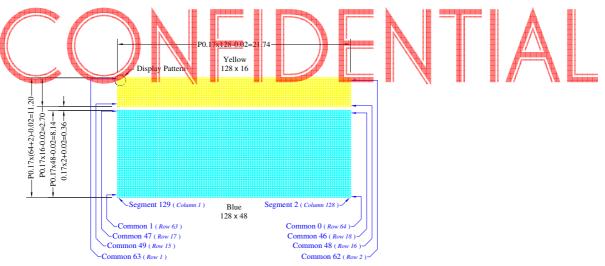
2) Number of Pixels:  $128 \times 64$ 

3) Panel Size:  $26.70 \times 19.26 \times 1.85$  (mm)

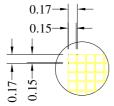
4) Active Area: 21.74 × 11.2 (mm)
 5) Pixel Pitch: 0.17 × 0.17 (mm)
 6) Pixel Size: 0.15 × 0.15 (mm)

7) Weight: TBD (g)

#### 1.3 Active Area & Pixel Construction



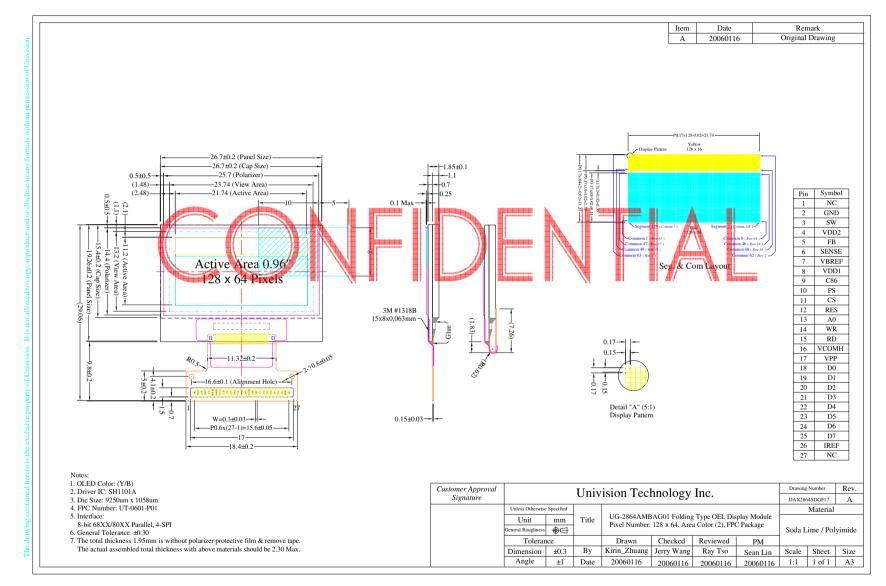
Seg. & Com Layout



Detail "A" (5:1) Display Pattern

# Univision

# Mechanical Drawing





## 1.5 Pin Definition

Pin Number	Symbol	I/O	Function
			Power Supply for Logic Circuit
8	VDD1	P	This is a voltage supply pin. It must be connected to
			external source.
			Ground of OEL System
2	GND	P	This is a ground pin. It also acts as a reference for the
			logic pins, the OEL driving voltages, and the analog circuits. It must be connected to external ground.
			Power Supply for OEL Panel
17	MDD	D	This is the most positive voltage supply pin of the chip.
17	VPP	P	It can be supplied externally or generated internally by
			using internal DC/DC voltage converter.
			Current Reference for Brightness Adjustment
26	IREF	О	This pin is segment current reference pin. A resistor
20	IKLI		should be connected between this pin and VSS. Set the
			current at 10uA.
			Voltage Output High Level for COM Signal
16	VCOMH	О	This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected
			between this pin and VSS.
			Power Supply for DC/DC Converter Circuit
			This is the power supply pin for the internal buffer of the
4	VDD2	P	This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to VDD
			when the converter is used. It must be floated when the
			converter is not used.
	SW		Output for Connected External NMOS
3		О	This output pin drives the gate of the external NMOS of
			the booster circuit.
6	SENSE	I O	Input for Connected External NMOS
U			This pin connects to the source current pin of the external NMOS of the booster circuit.
			Voltage Reference for DC/DC Converter Circuit
7	VBREF		This pin is the internal voltage reference of booster
7			circuit. A stabilization capacitor, typ. 1uF, should be
			connected to VSS.
			Feedback Input for DC/DC Converter Circuit
5	FB	I	This pin is the feedback resistor input of the booster
			circuit. It is used to adjust the booster output voltage
			level (VCC).
			Communicating Protocol Select These pins are MCU interface selection input. See the
9	C86	_	following table:
10	PS	I	6800-parallel 8080-parallel Serial
			C86 0 1 0
			PS 1 1 0
4.5		_	Power Reset for Controller and Driver
12	RES	I	This pin is reset signal input. When the pin is low,
			initialization of the chip is executed.
11	CC	т	Chip Select
11	CS	I	This pin is the chip select input. The chip is enabled for
II			MCU communication only when CS# is pulled low.



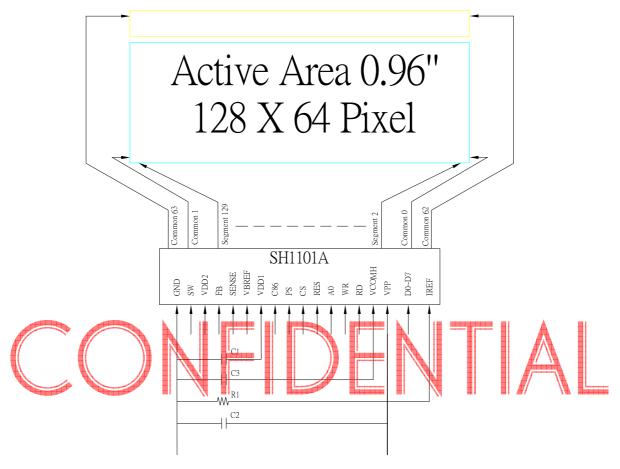
# 1.5 Pin Definition (Continued)

	Pin Number	Symbol	I/O	Function
	15	RD	I	Read/Write Enable or Read  This pin is MCU interface input. When interfacing to a 6800-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.  When connecting to an 8080-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
	14	WR	I	Read/Write Select or Write  This pin is MCU interface input. When interfacing to a 6800-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode.  When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
	13	AO	I	Data/Command Control  This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.
	25~18	D7~D0	I/O	Host Data Input/Output Bus  These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK.
	1, 27	N.C.	-	Reserved Pin (Supporting Pin)  The supporting pins can reduce the influences from stresses on the function pins.



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#### 1.6 Block Diagram



MCU Interface Selection: PS and C86

Pins connected to MCU interface: D7~D0, RD, WR, A0, RES, and CS \* VBREF, SENSE, FB, VDD2, SW, and GND should be left float.

C1,C2, C3:4.7µF

R1:  $910k\Omega$ , R1 = (Voltage at IREF - GND) / IREF

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#### 2. Absolute Maximum Ratings

#### 2.1 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage	$V_{\mathrm{DD1}}$	-0.3	3.5	V	1, 2
Driver Supply Voltage	$V_{PP}$	0	15	V	1, 2
Operating Temperature	$T_{OP}$	-20	70	°C	-
Storage Temperature	$T_{STG}$	-30	80	°C	-

Note 1: All the above voltages are on the basis of "GND = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

#### 2.2 Regarding the Gradation

Although this module possesses the gradation function, respective gradation levels will vary depending on the production conditions etc. Also, the temperature range where the gradation function can be guaranteed will be -10°C~60°C.

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#### 3. Electrical Characteristics

#### 3.1 DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	$V_{\mathrm{DD1}}$		2.6	2.8	3.5	V
DC/DC Supply Voltage	$V_{DD2}$		2.6	_	3.5	
Driver Supply Voltage	$V_{PP}$		7	_	15	V
High Level Input	$V_{IHC}$	$I_{out} = .0.5 \text{mA}, 3.3 \text{MHz}$	0.8×V <sub>DD1</sub>	-	$V_{DD1}$	V
Low Level Input	$V_{\rm ILC}$	I <sub>out</sub> =0.5mA, 3.3MHz	0	-	$0.2 \times V_{DD1}$	V
High Level Output	$V_{\mathrm{OHC}}$	$I_{out} = 0.5 \text{mA}, 3.3 \text{MHz}$	$0.8 \times V_{DD1}$	_	$V_{\mathrm{DD1}}$	V
Low Level Output	$V_{OLC}$	I <sub>out</sub> =0.5mA, 3.3MHz	0	_	$0.2 \times V_{DD1}$	V

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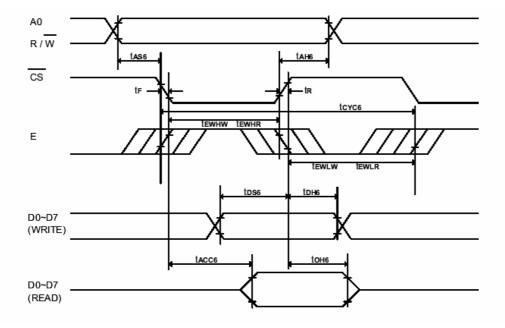
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#### 3.2 AC Characteristics

#### 3.2.1 6800-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>CYC6</sub>	System Cycle Time	300	-	ns
t <sub>AS6</sub>	Address Setup Time	0	-	ns
t <sub>AH6</sub>	Address Hold Time	0	-	ns
$t_{ m DS6}$	Write Data Setup Time	40	_	ns
$t_{ m DH6}$	Write Data Hold Time	15	_	ns
t <sub>OH6</sub>	Output Disable Time		70	ns
$t_{ACC6}$	Access Time	_	140	ns
$t_{\rm EWHW}$	Enable H pulse width (Write)	100	_	ns
$t_{\rm EWHR}$	Enable H pulse width (Read)	120		
$t_{EWLW}$	Enable L pulse width (Write)	100	-	ns
$t_{\rm EWLR}$	Enable L pulse width (Read)	100	\	
$t_{R}$	Rise Time		15	ns
t <sub>F</sub>	Fall Time	Æ	15	ns

\* All the timings should be based on 30% and 70% of  $V_{\rm DD1}$ -VSS.

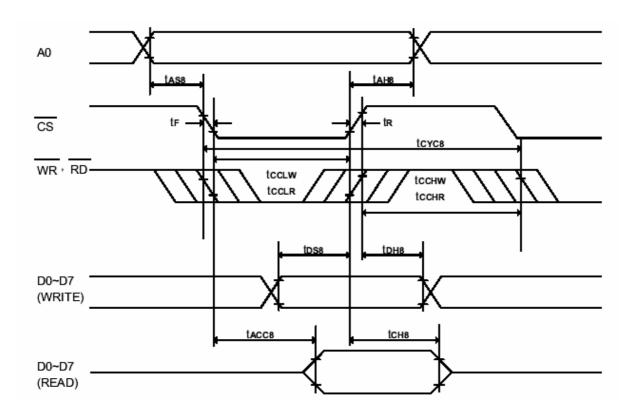




3.2.2 8080-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>CYC8</sub>	System Cycle Time	300	-	ns
t <sub>AS8</sub>	Address Setup Time	0	-	ns
t <sub>AH8</sub>	Address Hold Time	0	-	ns
$t_{ m DS8}$	Write Data Setup Time	40	-	ns
$t_{ m DH8}$	Write Data Hold Time	15	-	ns
$t_{\mathrm{CH8}}$	t <sub>CH8</sub> Output Disable Time		70	ns
t <sub>ACC8</sub>	/RD Access Time	-	140	ns
$t_{CCLW}$	Control L pulse width (WR)	100	-	ns
$t_{CCLR}$	Control L pulse width (RD)	120		
t <sub>CCHW</sub>	t <sub>CCHW</sub> Control H pulse width (WR)		_	ns
$t_{CCHR}$	t <sub>CCHR</sub> Control H pulse width (RD)			
$t_R$	Rise Time		15	ns
$t_{ m F}$	Fall Time	-	15	ns

All the timings should be based on 30% and 70% of  $V_{\rm DD1}$ -VSS.

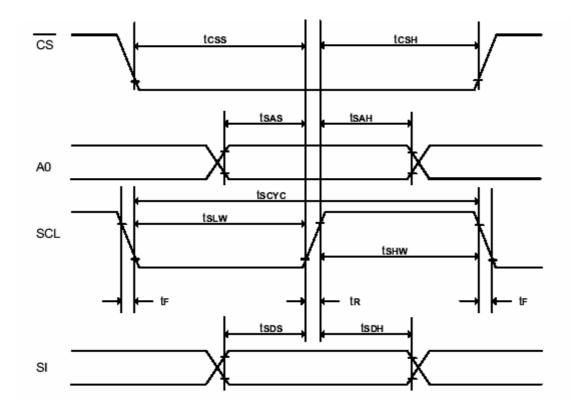


# 3.2.3 Serial Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
$T_{SCYC}$	Serial Clock Cycle Time	250	-	ns
$T_{SAS}$	Address Setup Time	150	_	ns
$T_{SAH}$	Address Hold Time	150	-	ns
$T_{SDS}$	Data Setup Time	100	_	ns
$T_{\mathrm{SDH}}$	Data Hold Time	100	-	ns
$T_{CSS}$	/CS Setup Time	120	-	ns
$T_{CSH}$	/CS Hold Time	60	-	ns
$T_{ m SHW}$	Serial clock H pulse width	100	-	ns
$T_{SLW}$	Serial clock L pulse width	100	_	ns
$t_{R}$	Rise Time	-	15	ns
$t_{F}$	Fall Time	-	15	ns

<sup>\*</sup> All the timings should be based on 30% and 70% of  $V_{DD1}$ -VSS

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# 3.3 Optics & Electrical Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness	$L_{br}$	With Polarizer	35	60	1	cd/m <sup>2</sup>
CIE (Dlug)	(x)	Without Dolonizon	0.12	0.16	0.20	
C.I.E. (Blue)	(y)	Without Polarizer	0.22	0.26	0.30	
CIE (Vollow)	(x)	Without Polarizer	0.43	0.47	0.51	
C.I.E. (Yellow)	(y)		0.46	0.50	0.54	
Dark Room Contrast	CR		-	>1:100	-	
View Angle			>160	_	_	degree

Note 3: Optical measurement taken at 1/64 duty, 100Hz Frame Rate, 0xFF Contrast Setting.

#### 3.4 General Electrical Specification

	Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
	Supply Voltage	$V_{\mathrm{DD1}}$		2.6	2.8	3.5	V
	DC/DC Supply Voltage	V <sub>DD2</sub>		2.6		3.5	V
	Driver Supply Voltage	$V_{ extsf{P}P}$		8	9	10	V
	Operating Current for	<b>T</b>	Note 4	TBD	180	<b>3</b> 20	μΑ
8 188	$V_{\mathrm{DD1}}$	IDD1	Note 5	TBD	180	320	μĀ
	Operating Current for	T	Note 4	-	5.5	6.8	mA
	$V_{PP}$	$ m I_{PP}$	Note 5	-	7.8	9.7	mA

Note 4:  $V_{DD1} = 2.8V$ ,  $V_{PP} = 9V$ , Frame Rate = 100Hz, Contrast Setting = 0x64, 50% Display Area Turn on.

Note 5:  $V_{DD1} = 2.8V$ ,  $V_{PP} = 9V$ , Frame Rate = 100Hz, Contrast Setting = 0x64, 100% Display Area Turn on.

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## 4. Functional Specification

#### 4.1. Commands

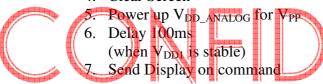
Refer to the Technical Manual for the SH1101A

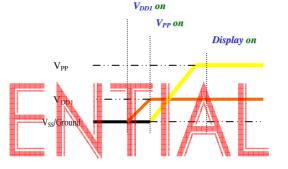
#### 4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

#### 4.2.1 Power up Sequence:

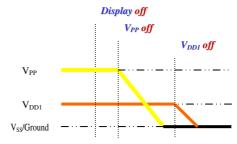
- 1. Power up  $V_{DD1}$
- 2. Delay 100ms at least (when reset process is finished)
- 3. Send Display off command
- 4. Clear Screen





#### 4.2.2 Power down Sequence:

- 1. Send Display off command
- 2. Power down  $V_{DD\ ANALOG}$  for  $V_{PP}$
- 3. Delay 100ms (when V<sub>PP</sub> is reach 0 and panel is completely discharges)
- 4. Power down V<sub>DD1</sub>



#### 4.3 Reset Circuit

When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 132×64 Display Mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00H and COM0 mapped to row address 00H)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 80H
- 9. Internal booster is selected



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#### 4.4 Actual Application Example

Command usage and explanation of an actual example

<Initialization Setting>
Set Display Clock Divide Ratio / Oscillator Frequency
(11010101 with XXXXXXXXX)

Set Display Offset
(11010011 with \*\*XXXXXX)

\* XXXXXX = 64 - Dummy Lines from Common 0
Set Multiplex Ratio
(10101000 with \*\*XXXXXX)

Set DC/DC On/Off
(10101101 with 1000101X)
10001010 => 0x8A (Off)
Set Area Color Mode & Low Power Display Mode
(11011000 with 00XX0X0X)
00000101 => 0x05 (Mono & Low Power Save Mode)

# Set Display Start Line (01XXXXXXX) Set Segment Re-map (1010000X)

Set COM Output Scan Direction
(1100X\*\*\*)
Set COM Pins Hardware Configuration
(11011010 with 000X0010)
00010010 => 0x12 (Alternative Mode)

Set Contrast Control Register (10000001 with XXXXXXXX)

Set Entire Display On/Off (1010010X) 10100100 => 0xA4 (Normal) Set Normal/Inverse Display (1010011X) 10100110 => 0xA6 (Normal) Set Display On/Off (1010111X) 10101111 => 0xAF (Turns On)

<Display Boundary Setting>
 Set Page Address (1011XXXX)
 10110000 => 0xB0
 Set Lower Column Address
 (0000XXXX)
 Set Higher Column Address
 (0001XXXX)

If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.



### 5. Outgoing Quality Control Specifications

#### 5.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:  $23 \pm 5^{\circ}\text{C}$ Humidity:  $55 \pm 15 \%\text{RH}$ 

Fluorescent Lamp: 30W Distance between the Panel & Lamp:  $\geq$  50 cm Distance between the Panel & Eyes of the Inspector:  $\geq$  30 cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

#### 5.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

5.3	Criteria & Ac	cceptable Qua	lity Level			
	Partition /	AQL		Definit	on	
	Major	1.0	Defects in Patte	ern Check (Dis	play On)	



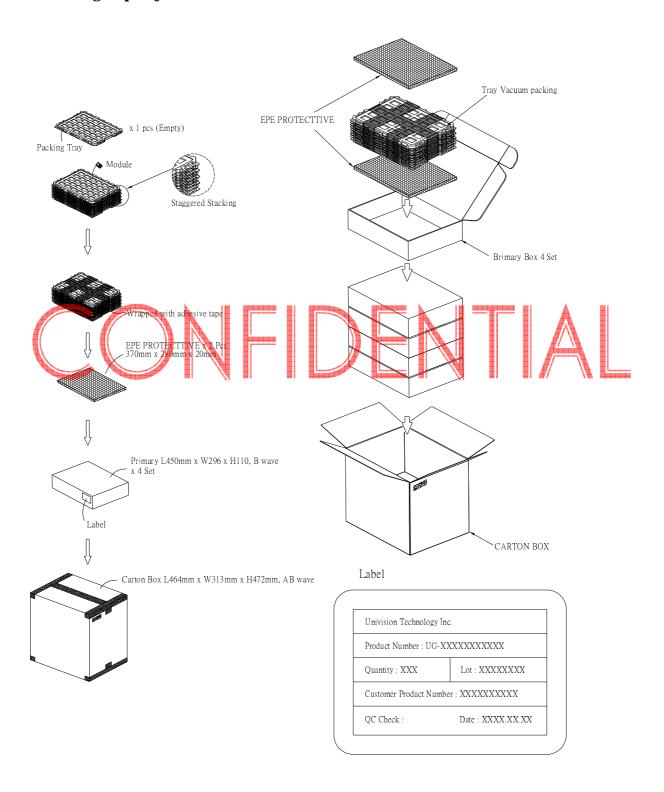
Doc. No: SAS1-9015-A

Criteria of Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria		
No Display	Major			
Flicker	Major	Not Allowable		
Missing Line	Major			
Pixel Short	<b>M</b> ajor			
Darker Pixel	Major			
Wrong Display	Major			
Un-uniform	Major			

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# 6. Package Specifications





#### 7. Precautions When Using These OEL Display Modules

#### 7.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water

  \* Ketone

  \* Aromatic Solvents

  When installing the OEL display module, be careful not to apply twisting stress or deflection stress to the OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.
  - 7) Do not apply stress to the LSI chips and the surrounding molded sections.
  - 8) Do not disassemble nor modify the OEL display module.
  - 9) Do not apply input signals while the logic power is off.
  - 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
    - \* Be sure to make human body grounding when handling OEL display modules.
    - \* Be sure to ground tools to use or assembly such as soldering irons.
    - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
    - \* Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
  - 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
  - 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.



#### 7.2 Storage Precautions

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Univision Technology Inc.)
  - At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

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2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### 7.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal/line cable as short as possible.
  - We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
  - 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
  - 5) As for EMI, take necessary measures on the equipment side basically.
  - 6) When fastening the OEL display module, fasten the external plastic housing section.
  - 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
  - 8) The electric potential to be connected to the rear face of the IC chip should be as follows: STV 8105
    - \* Connection (contact) to any other potential than the above may lead to rupture of the IC.

#### 7.4 Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### 7.5 Other Precautions



When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

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- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the TCP
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
  - \* Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
  - \* Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
  - We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.